Surface Mounting Optoelectronic Component and Method For Producing Same

ABSTRACT OF THE DISCLOSURE

A method for producing a surface mounting optoelectronic component comprises the following steps: readying a base body with the optoelectronic transmitter and/or receiver arranged in a recess of the base body, filling the recess of the base body with a transparent, curable casting compound, and placing the optical device onto the base body, whereby the optical device comes into contact with the casting compound.

Figure 2C

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